SP01-300A



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

John F. Filhaber et al.

Examiner: To Be Assigned

Serial No:

10/255,777

Group Art Unit: 2874

Filed:

September 25, 2002

For:

DIRECT BONDING OF OPTICAL

COMPONENTS

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98

Asst. Commissioner of Patents and Trademarks

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference(s) is enclosed.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

Timothy M. Schaeberle Registration No. 34,424 Corning Incorporated

SP-TI-03-1

Corning, NY 14831

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Date:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Asst. Commissioner of Patents and Trademarks, Arlington, VA 22313 on

Date of Deposit

THUR C.

Revision: March 7, 2000

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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANTS INFORMATION DISCLOSURE STATEMENT				SI	10/255,777				
				APPLICANT Filhaber et al.					
				FILING DATE September 25, 2002			GROUP: 2874		
REFERE	ENCE I	DESIGNATION		U.S. PATENT	DOCUMEN	TS			
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	AR	OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.) Andreas Plobl et al., Wafer Direct Bondiong: Tailoring Adhesion Between Brittle Materials, Materials Science and Engineering, R25 (1999) pp. 1-88.							
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.